

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHAO-MING YU	12/16/2014
CHANG-YUN CHANG	12/17/2014
CHIH-HAO CHANG	12/17/2014
HSIN-CHIH CHEN	12/16/2014
KAI-TAI CHANG	12/16/2014
MING-FENG SHIEH	12/23/2014
KUEI-LIANG LU	12/23/2014
YI-TANG LIN	12/17/2014
RECEIVING PARTY DATA	
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. 6
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300-77
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16726405
CORRESPONDENCE DATA	
Fax Number:	(214)200-0853
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	214-651-5000
Email:	ipdocketing@haynesboone.com
Correspondent Name:	HAYNES AND BOONE, LLP IP SECTION
Address Line 1:	2323 VICTORY AVENUE
Address Line 2:	SUITE 700
Address Line 4:	DALLAS, TEXAS 75219
ATTORNEY DOCKET NUMBER:	20110876 / 24061.3047US03
NAME OF SUBMITTER:	JANIE MARTINEZ-HOLM

PATENT

SIGNATURE:	/Janie Martinez-Holm/
DATE SIGNED:	12/06/2021
Total Attachments: 4 source=24061.3047US03 - Assignment (Parent)#page1.tif source=24061.3047US03 - Assignment (Parent)#page2.tif source=24061.3047US03 - Assignment (Parent)#page3.tif source=24061.3047US03 - Assignment (Parent)#page4.tif	

ASSIGNMENT

WHEREAS, we,

- (1) Shao-Ming Yu of Taiwan 300-77, Republic of China.
- (2) Chang-Yun Chang of Taiwan 300-77, Republic of China
- (3) Chih-Hao Chang of Taiwan 300-77, Republic of China
- (4) Hsin-Chih Chen of Taiwan 300-77, Republic of China
- (5) Kai-Tai Chang of Taiwan 300-77, Republic of China
- (6) Ming-Feng Shieh of Taiwan 300-77, Republic of China
- (7) Kuei-Liang Lu of Taiwan 300-77, Republic of China
- (8) Yi-Tang Lin of Taiwan 300-77, Republic of China

have invented certain improvements in

**STRUCTURE AND METHOD FOR PROVIDING LINE END EXTENSIONS
FOR FIN-TYPE ACTIVE REGIONS**

for which we have executed an application for Letters Patent of the United States of America,

 X of even date filed herewith; and
 filed on and assigned application number ; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue

patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name: Shao-Ming Yu

Residence Address: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu
Taiwan 300-77, R.O.C.

✓
Dated: 2014/12/16

✓ Shao-Ming Yu.
Inventor Signature

Inventor Name: Chang-Yun Chang

Residence Address: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu
Taiwan 300-77, R.O.C.

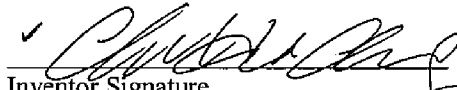
✓
Dated: Chang-Yun C
2014/12/17

✓ Chang-Yun Chang
Inventor Signature

Inventor Name: Chih-Hao Chang

Residence Address: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu
Taiwan 300-77, R.O.C.

✓ Dated: 2014/12/17

✓ 
Inventor Signature

Inventor Name: Hsin-Chih Chen

Residence Address: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu
Taiwan 300-77, R.O.C.

✓ Dated: 2014/12/16

✓ Hsin-Chih Chen
Inventor Signature

Inventor Name: Kai-Tai Chang

Residence Address: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu
Taiwan 300-77, R.O.C.

✓ Dated: 2014/12/16

✓ Kai-Tai Chang
Inventor Signature

Inventor Name: Ming-Feng Shieh

Residence Address: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu
Taiwan 300-77, R.O.C.

✓ Dated: 2014/12/23

✓ Ming-Feng Shieh
Inventor Signature

Inventor Name: Kuei-Liang Lu

Residence Address: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu
Taiwan 300-77, R.O.C.

✓ Dated: 2014. 12. 23

✓ Kuei-Liang Lu
Inventor Signature

Inventor Name: Yi-Tang Lin

Residence Address: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu
Taiwan 300-77, R.O.C.

✓ Dated: 2014-12-17

✓ Yi-Tang Lin
Inventor Signature